

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

ECH8655R — General-Purpose Switching Device Applications

Features

- · Low ON-resistance
- · 2.5V drive
- · Common-drain type
- · Protection diode in

- · Built-in gate protection resistor
- · Best suited for LiB charging and discharging switch
- · Halogen free compliance

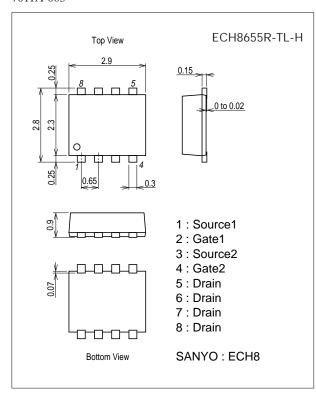
Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		24	V
Gate-to-Source Voltage	V _{GSS}		±12	V
Drain Current (DC)	ID		9	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	60	А
Allowable Power Dissipation	PD	When mounted on ceramic substrate (900mm ² ×0.8mm) 1unit	1.4	W
Total Dissipation	PT	When mounted on ceramic substrate (900mm ² ×0.8mm)	1.5	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit : mm (typ.) 7011A-003

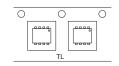


Product & Package Information

Package : ECH8JEITA, JEDEC : -

• Minimum Packing Quantity : 3,000 pcs./reel

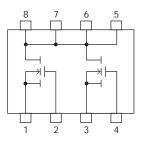
Packing Type: TL



Marking



Electrical Connection

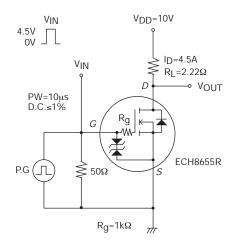


ECH8655R

Electrical Characteristics at Ta=25°C

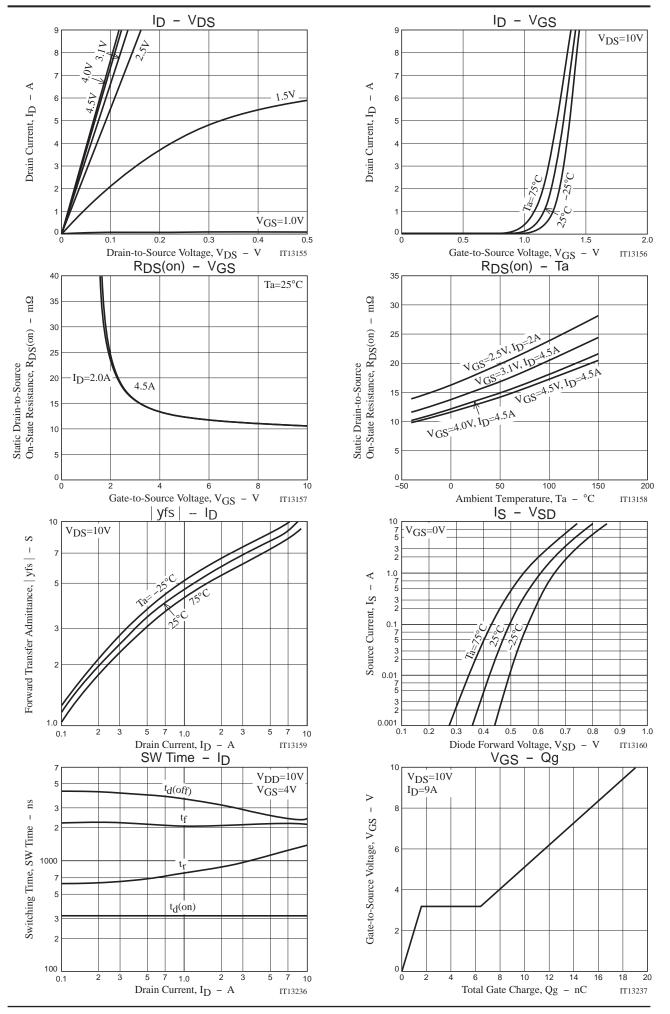
Parameter	Cumbal	Conditions	Ratings			Unit	
Parameter	Symbol	Conditions	min.	typ.	max.	Unit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	24			V	
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =20V, V _{GS} =0V			1	μΑ	
Gate-to-Source Leakage Current	IGSS	V _{GS} =±8V, V _{DS} =0V			±10	μΑ	
Cutoff Voltage	V _{GS} (off)	V _{DS} =10V, I _D =1mA	0.5		1.3	V	
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =4.5A	4.8	8		S	
	R _{DS} (on)1	I _D =4.5A, V _G S=4.5V	9	13	17	mΩ	
Static Drain to Source On State Decistance	R _{DS} (on)2	I _D =4.5A, V _G S=4.0V	9	13.5	18	$m\Omega$	
Static Drain-to-Source On-State Resistance	R _{DS} (on)3	I _D =4.5A, V _G S=3.1V	9.2	15	21	mΩ	
	RDS(on)4	ID=2A, VGS=2.5V	10.5	18	25.5	mΩ	
Turn-ON Delay Time	t _d (on)			320		ns	
Rise Time	t _r	Con appointed Toot Circuit		1100		ns	
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		2400		ns	
Fall Time	tf			2100		ns	
Total Gate Charge	Qg			16.8		nC	
Gate-to-Source Charge	Qgs	V _{DS} =10V, V _{GS} =10V, I _D =9A		1.6		nC	
Gate-to-Drain "Miller" Charge	Qgd			4.8		nC	
Diode Forward Voltage	V _{SD}	IS=9A, VGS=0V		0.8	1.2	V	

Switching Time Test Circuit

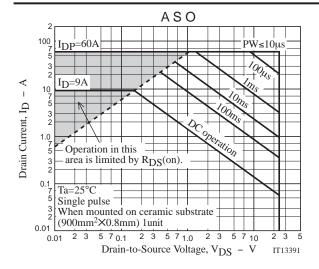


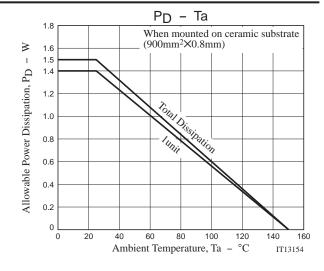
Ordering Information

Device	Package	Shipping	memo	
ECH8655R-TL-H	ECH8	3,000pcs./reel	Pb Free and Halogen Free	



ECH8655R



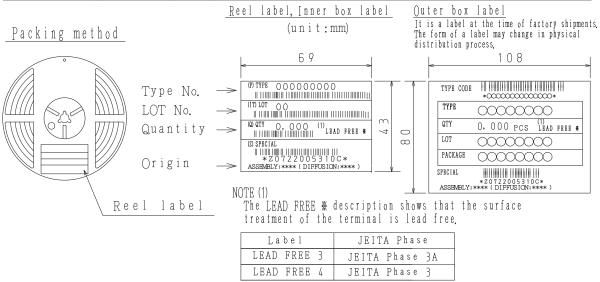


Embossed Taping Specification

ECH8655R-TL-H

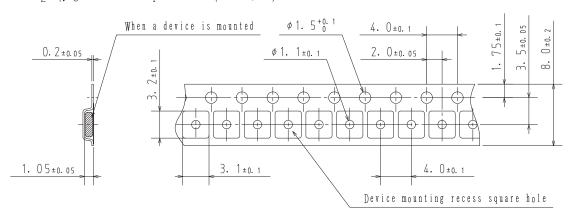
1. Packing Format

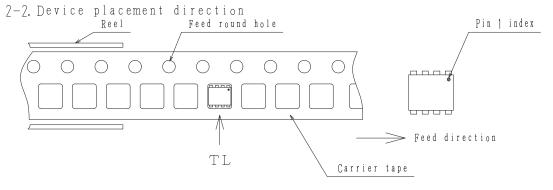
Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing	format
	Туре	Reel	Inner box	Outer box	Inner $BOX(C-1)$	Outer BOX (A-7)
ECH8	СРН6	3, 000	15, 000	90,000	5 reels contained	6 inner boxes contained
					Dimensions:mm (external)	Dimensions:mm (external)
					183×72×185	440×195×210



2. Taping configuration

2-1. Carrier tape size (unit:mm)





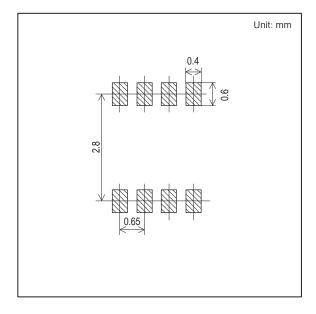
Those with pin 1 index on the feed hole side · · · · · TL

Outline Drawing

ECH8655R-TL-H

Mass (g) Unit 0.02 * For reference mm 0. 15^{+0. 1}_{-0. 05} 0. 25±0.06 2. 9±0.06 0~0.02 2. 8±0. 05 2. 3±0.06 LOT No. 0. 25±0.06 0. 3^{+0. 1} 0.65 PIN#1 0. 9±0. 05 0.05 \$ \$

Land Pattern Example



Note on usage: Since the ECH8655R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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